

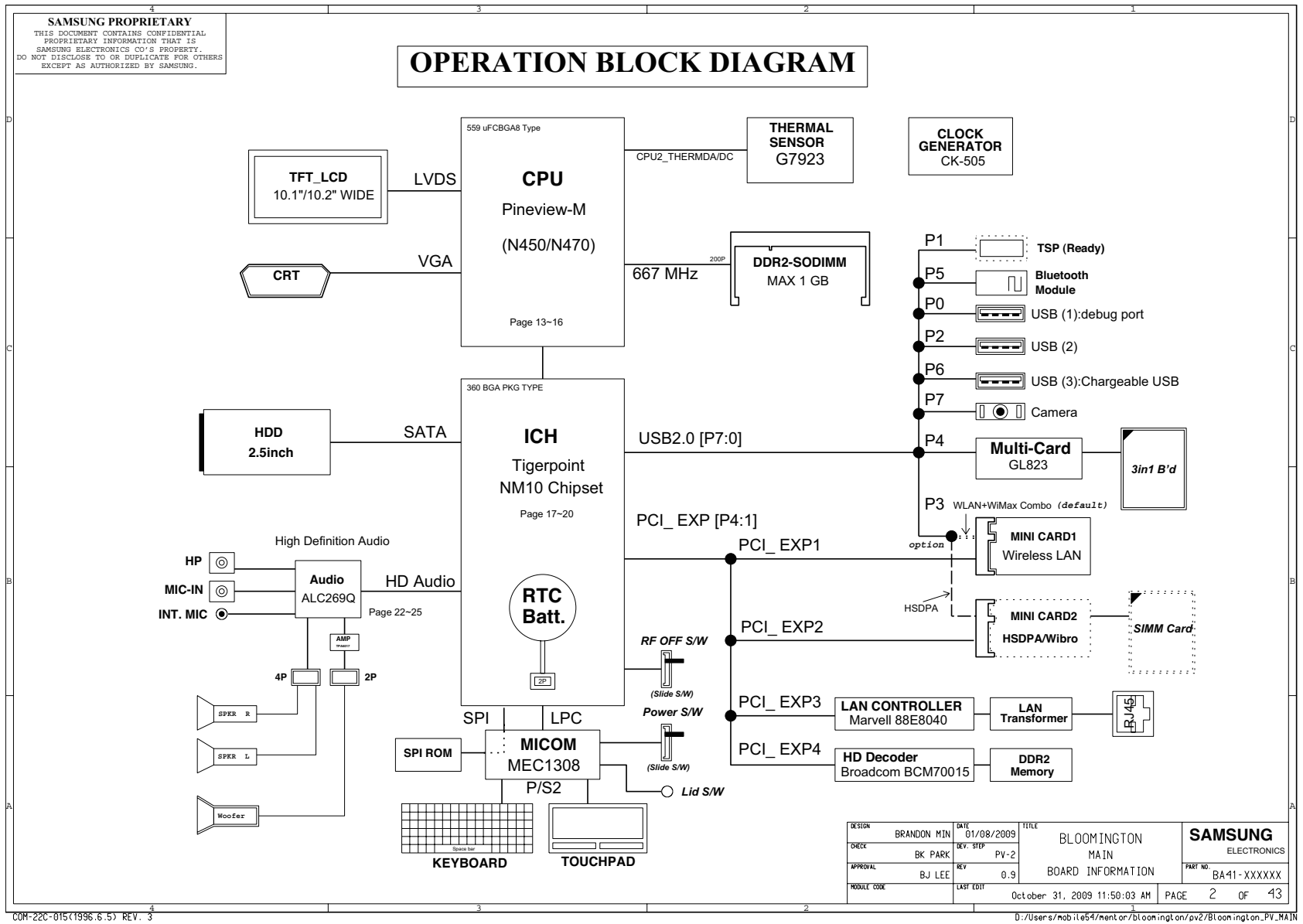
8. Block Diagram and Schematic

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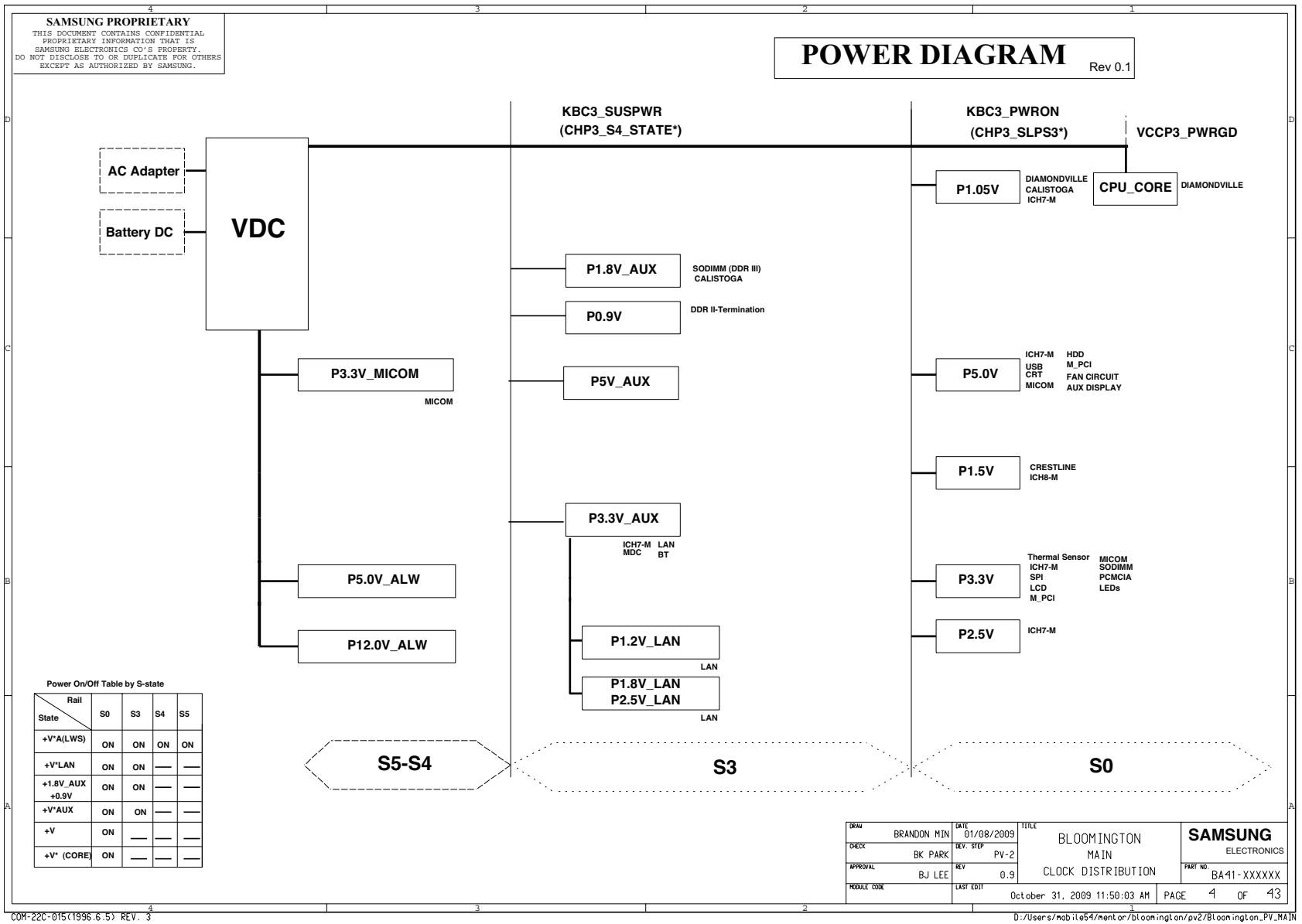
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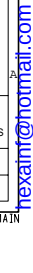
8. Block Diagram and Schematic



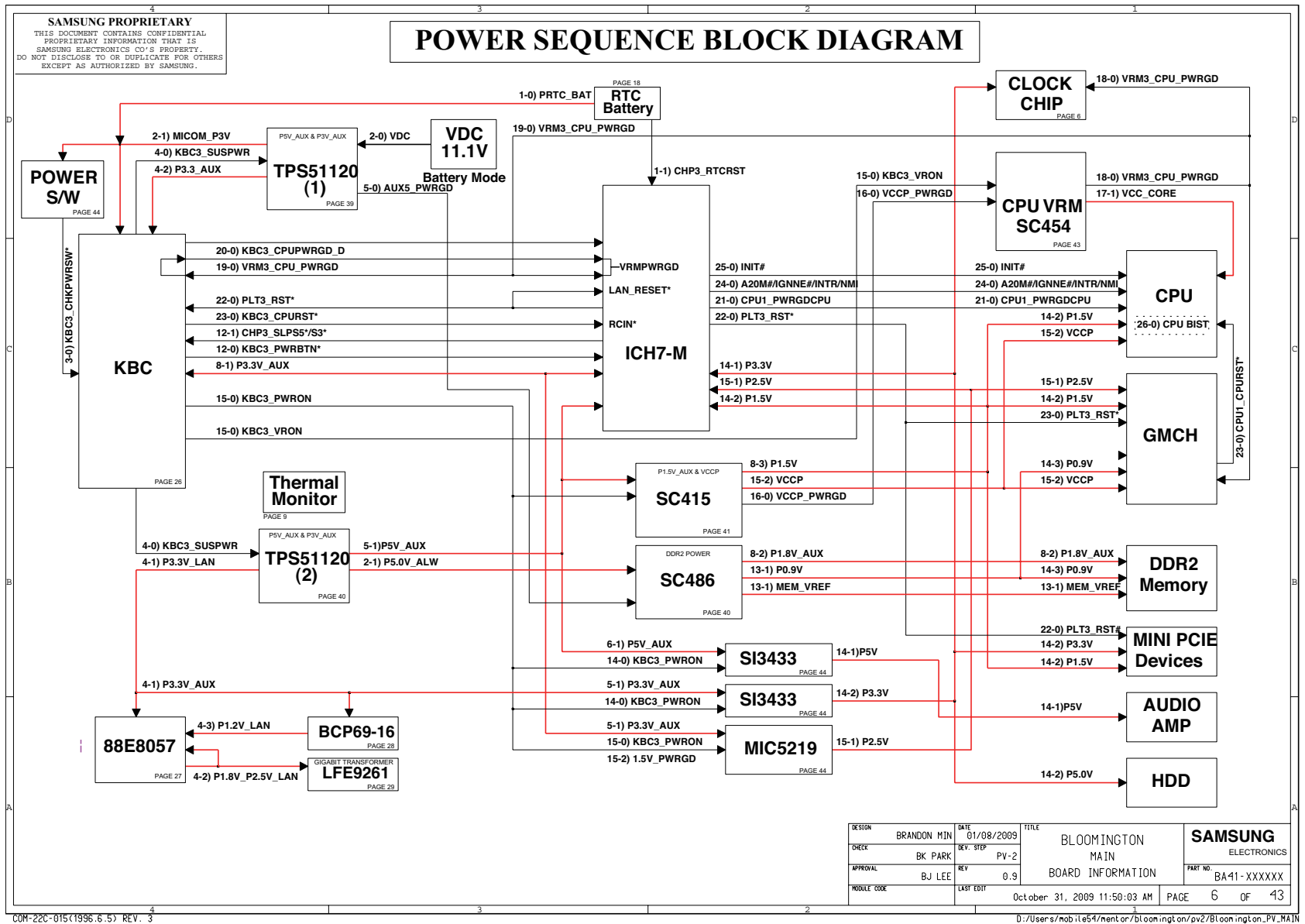
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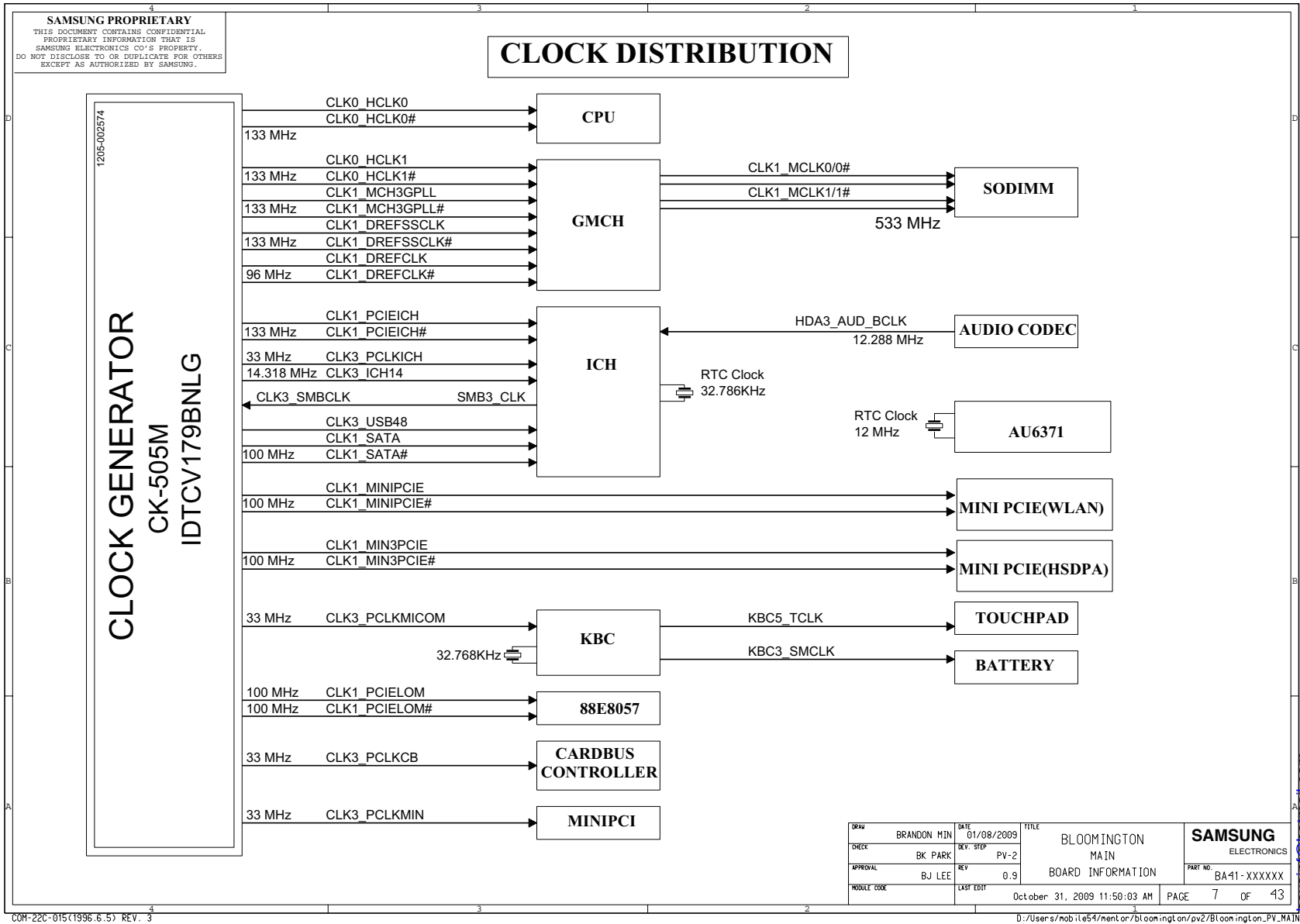


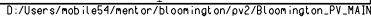


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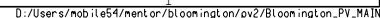




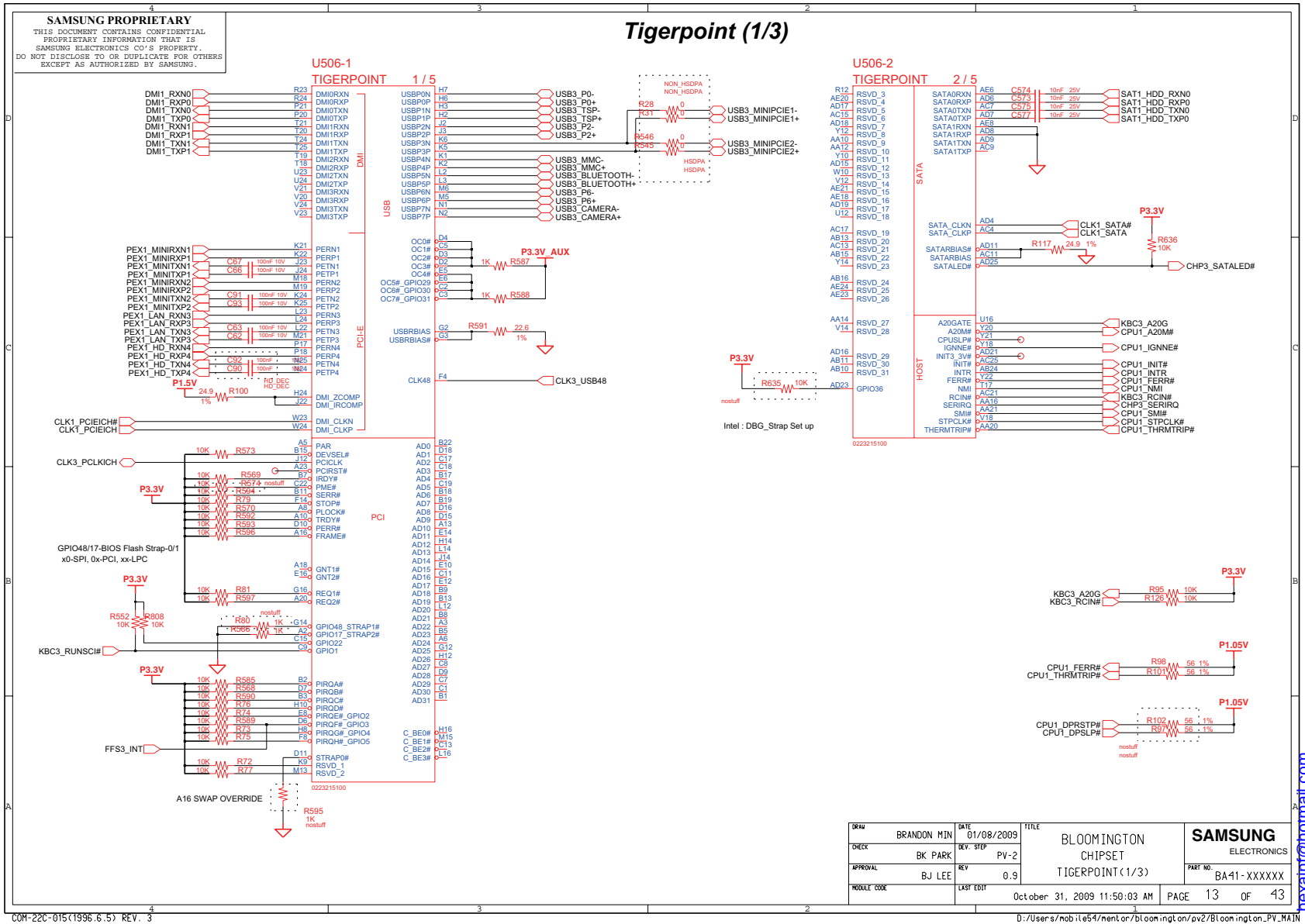


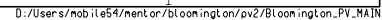






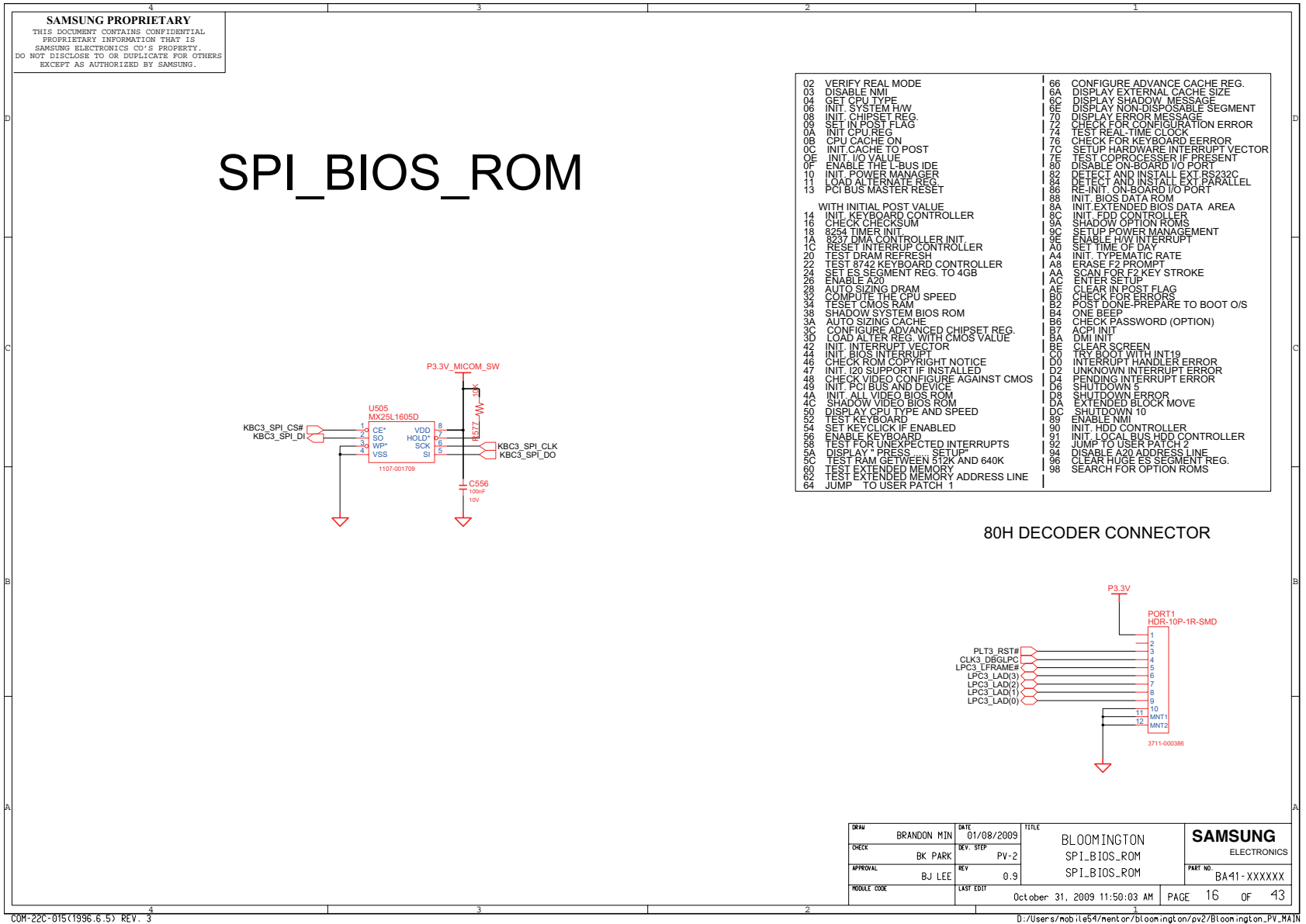
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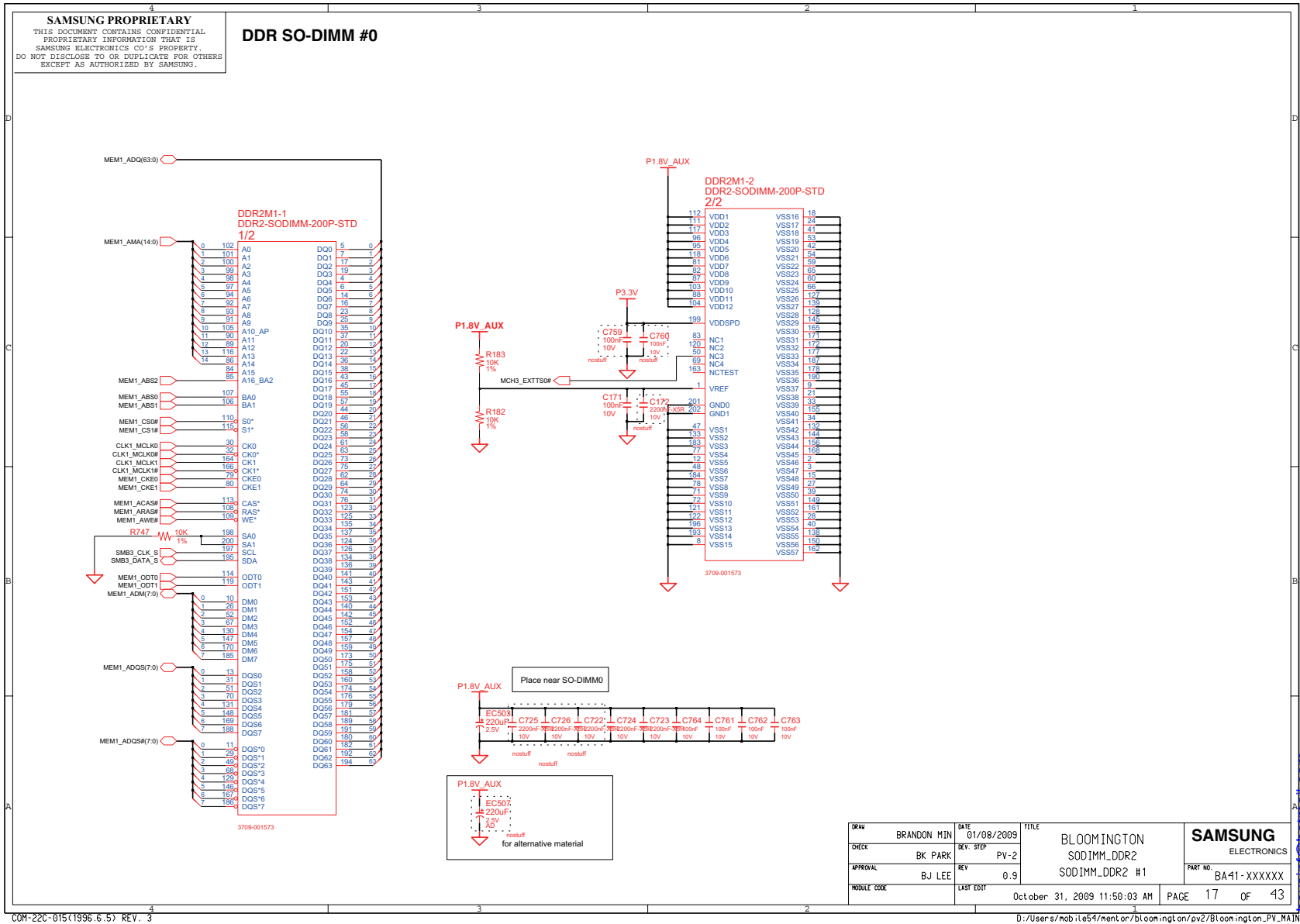




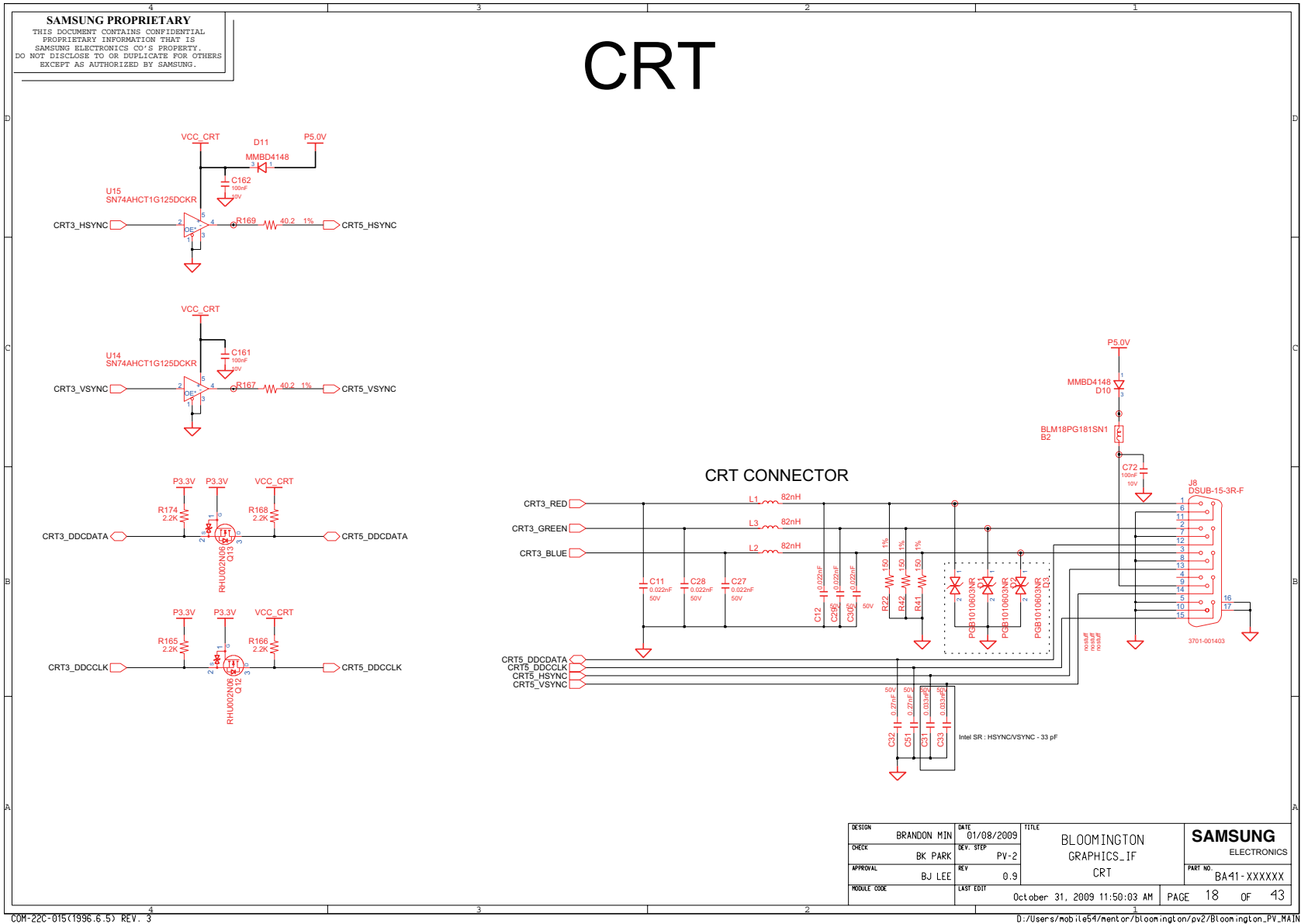
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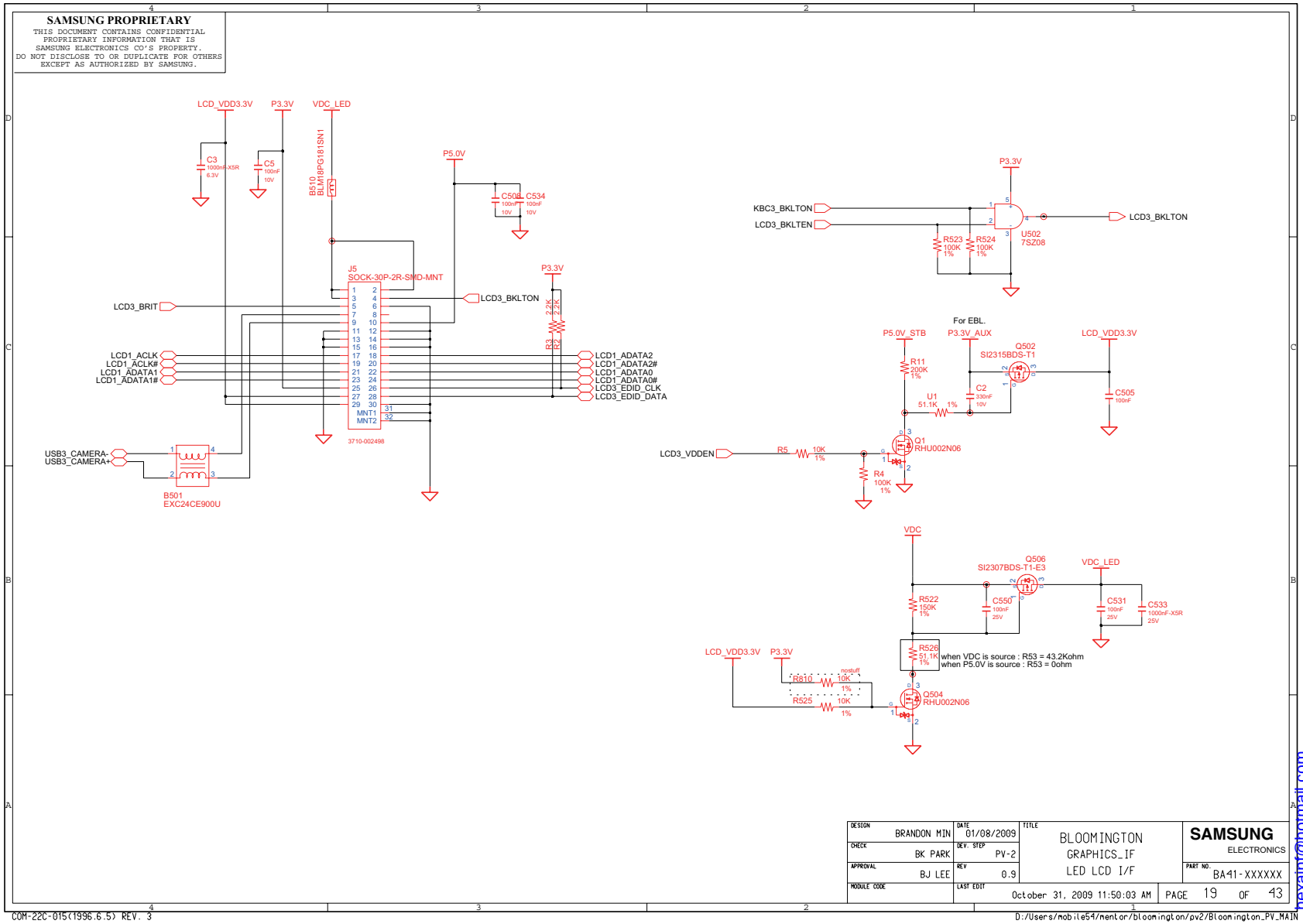
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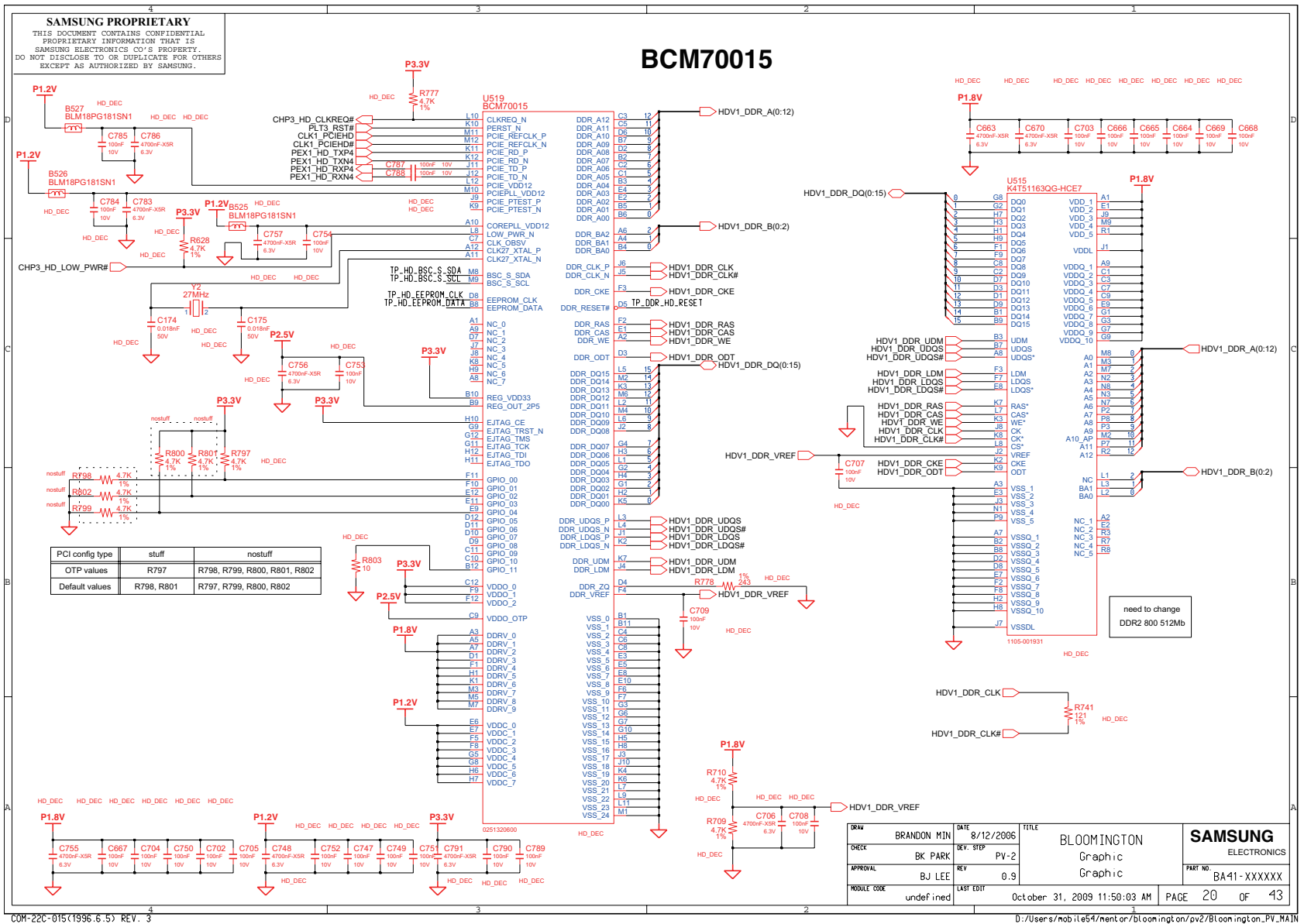
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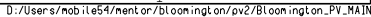
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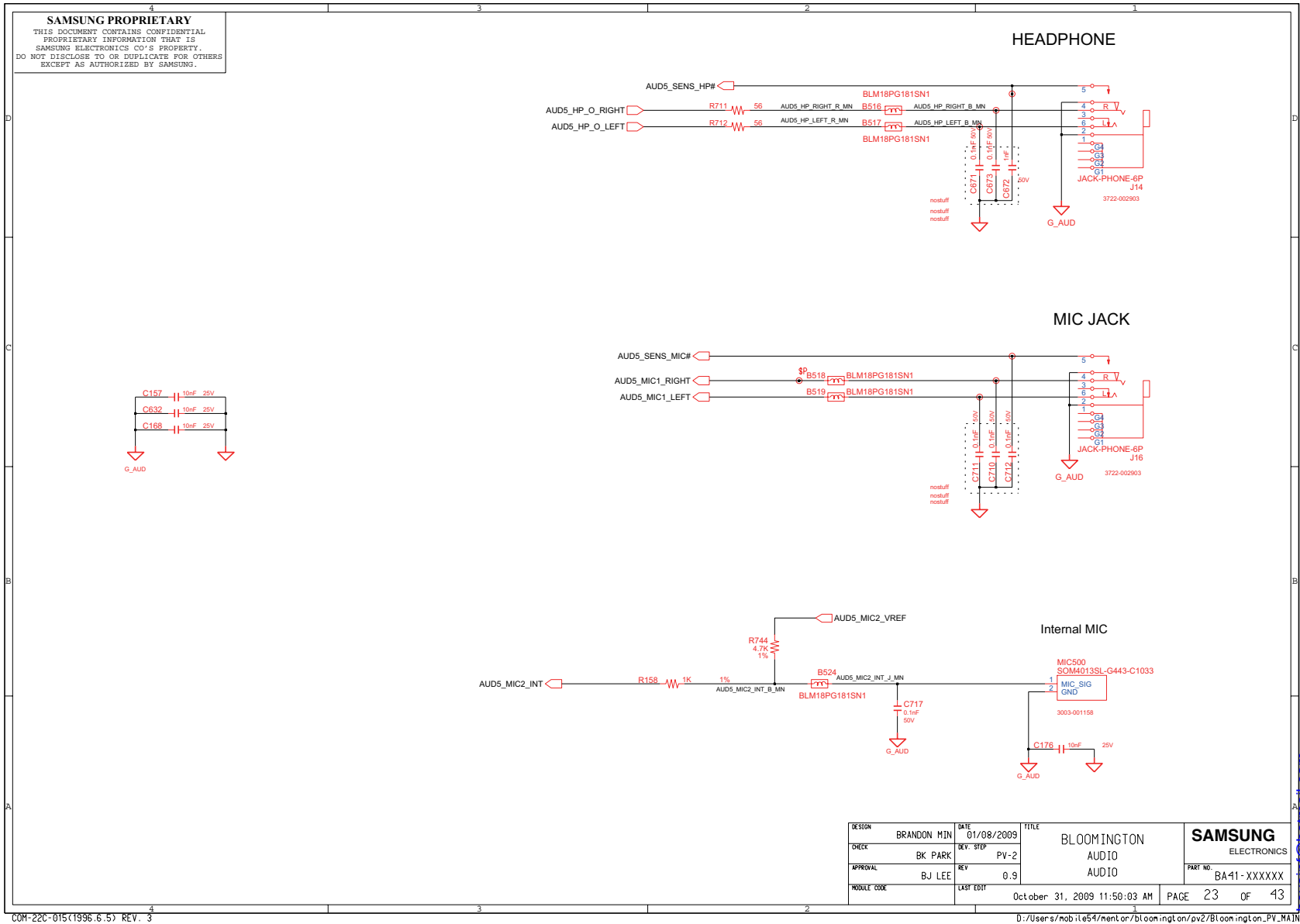
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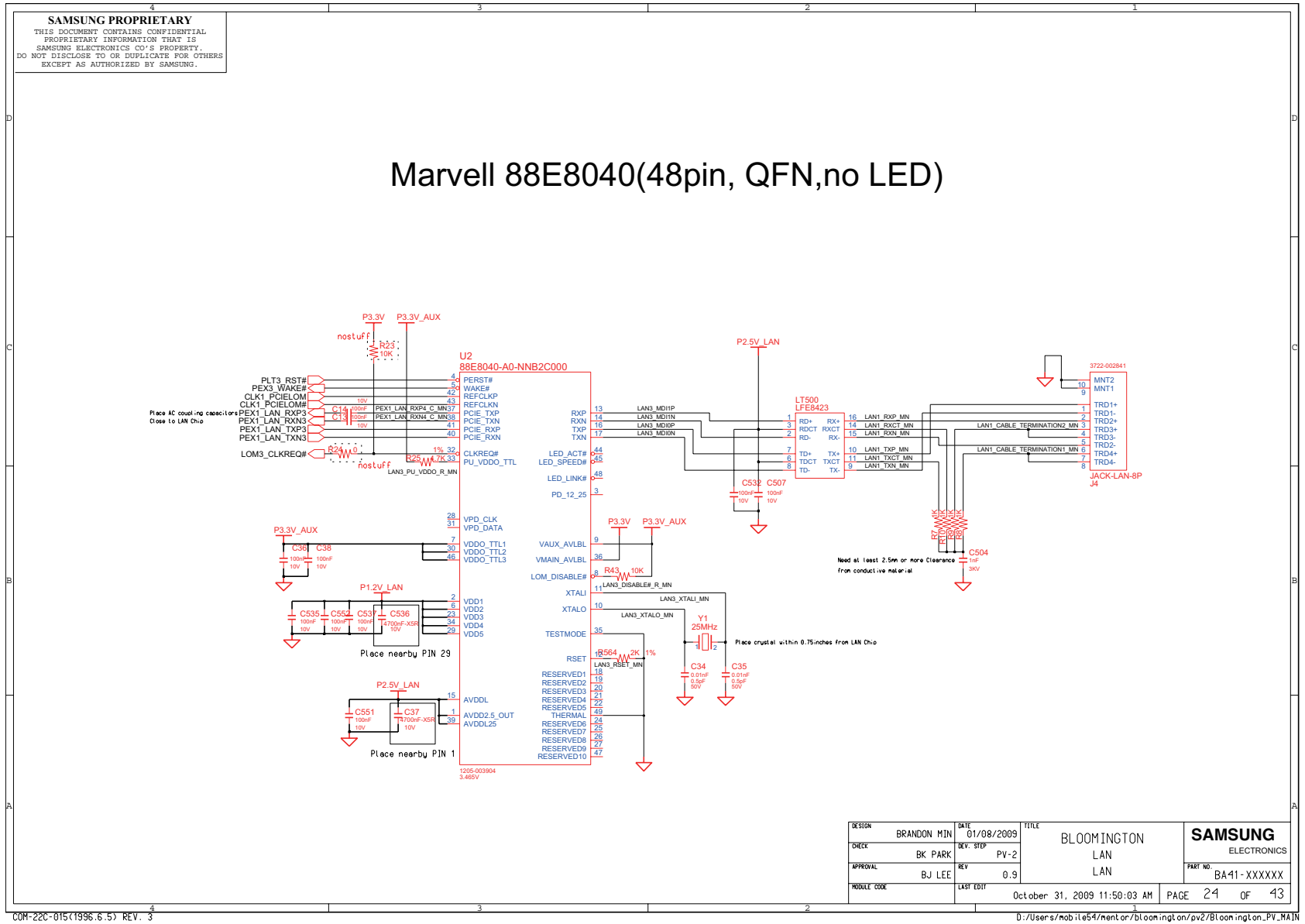




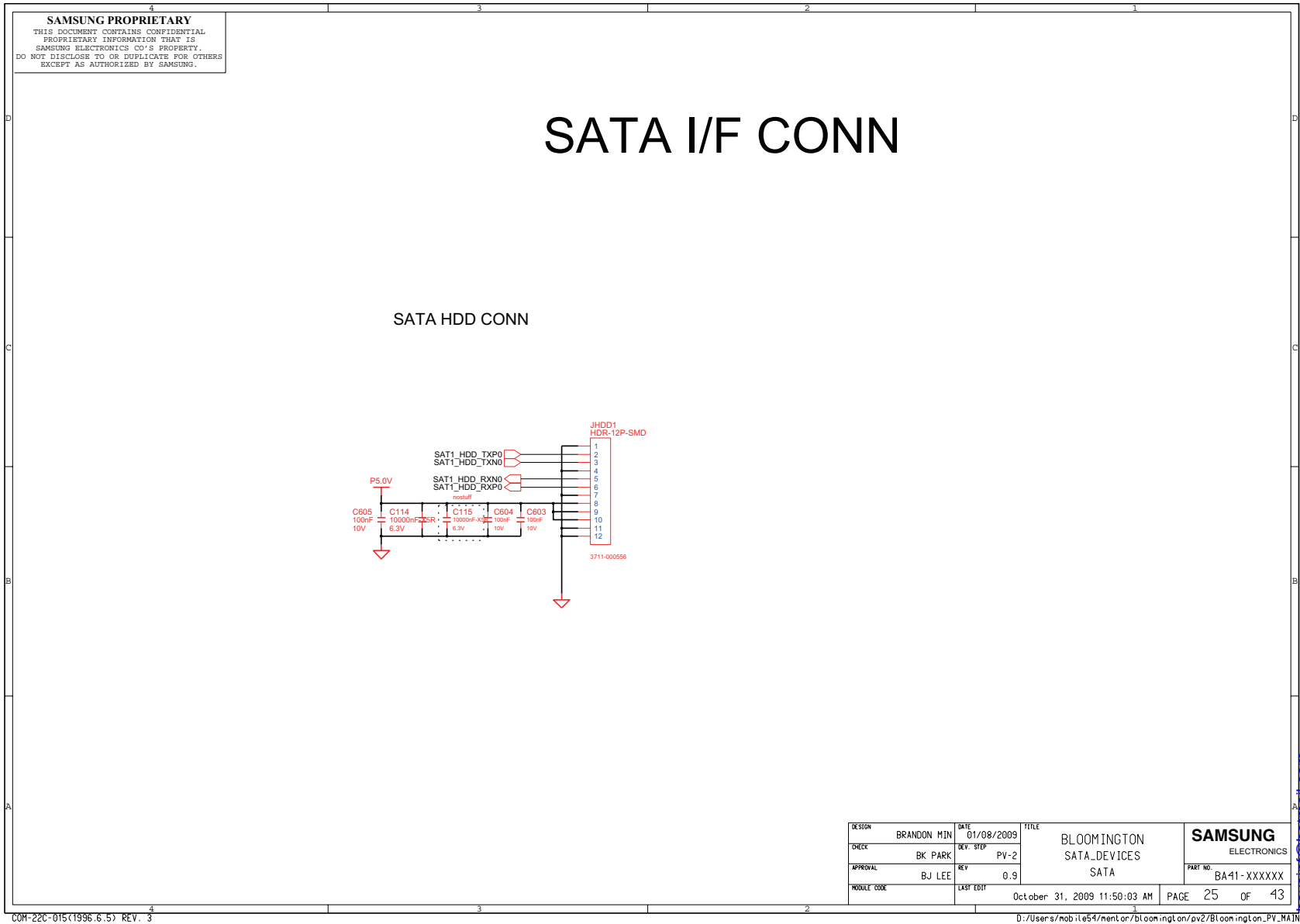
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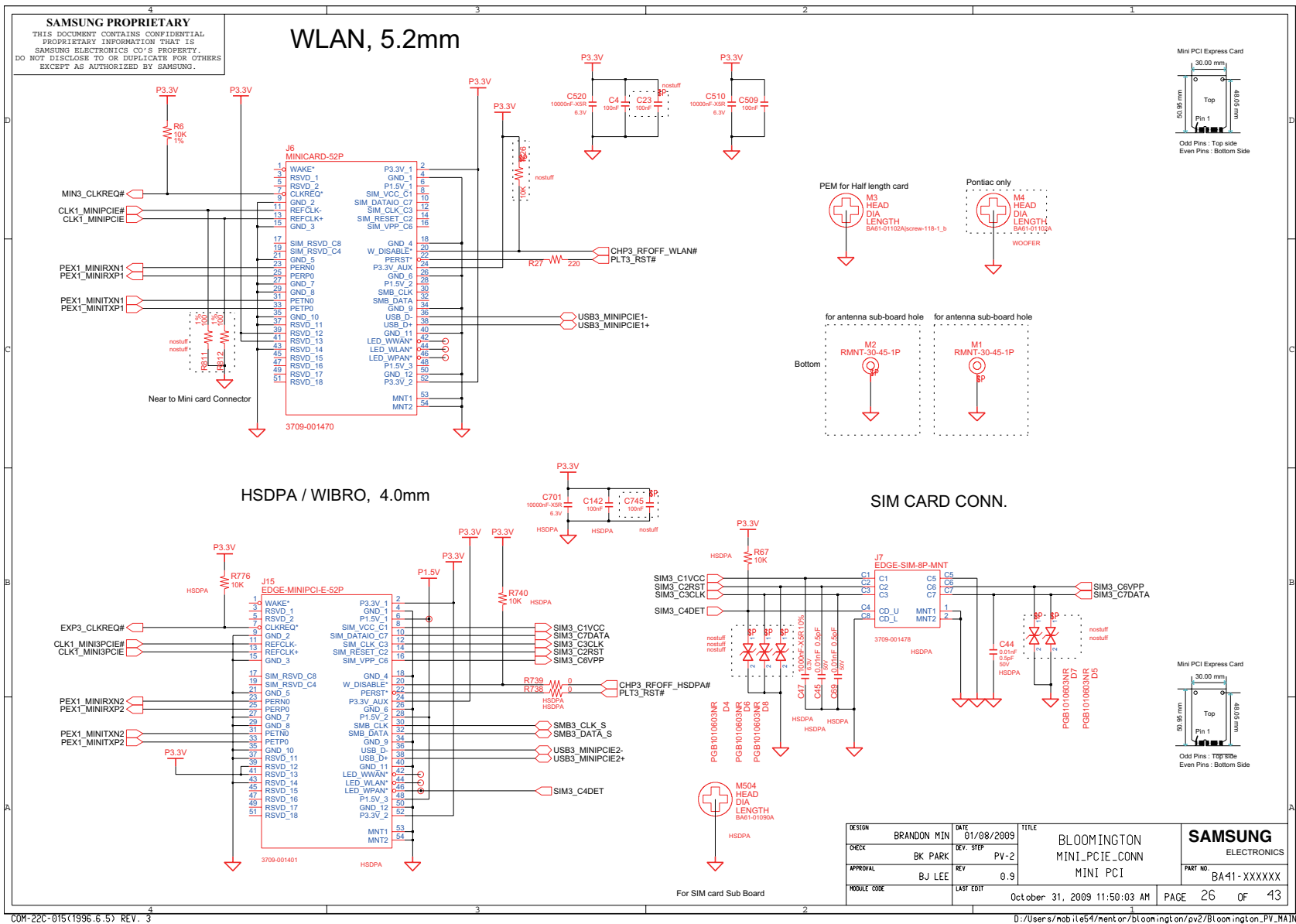
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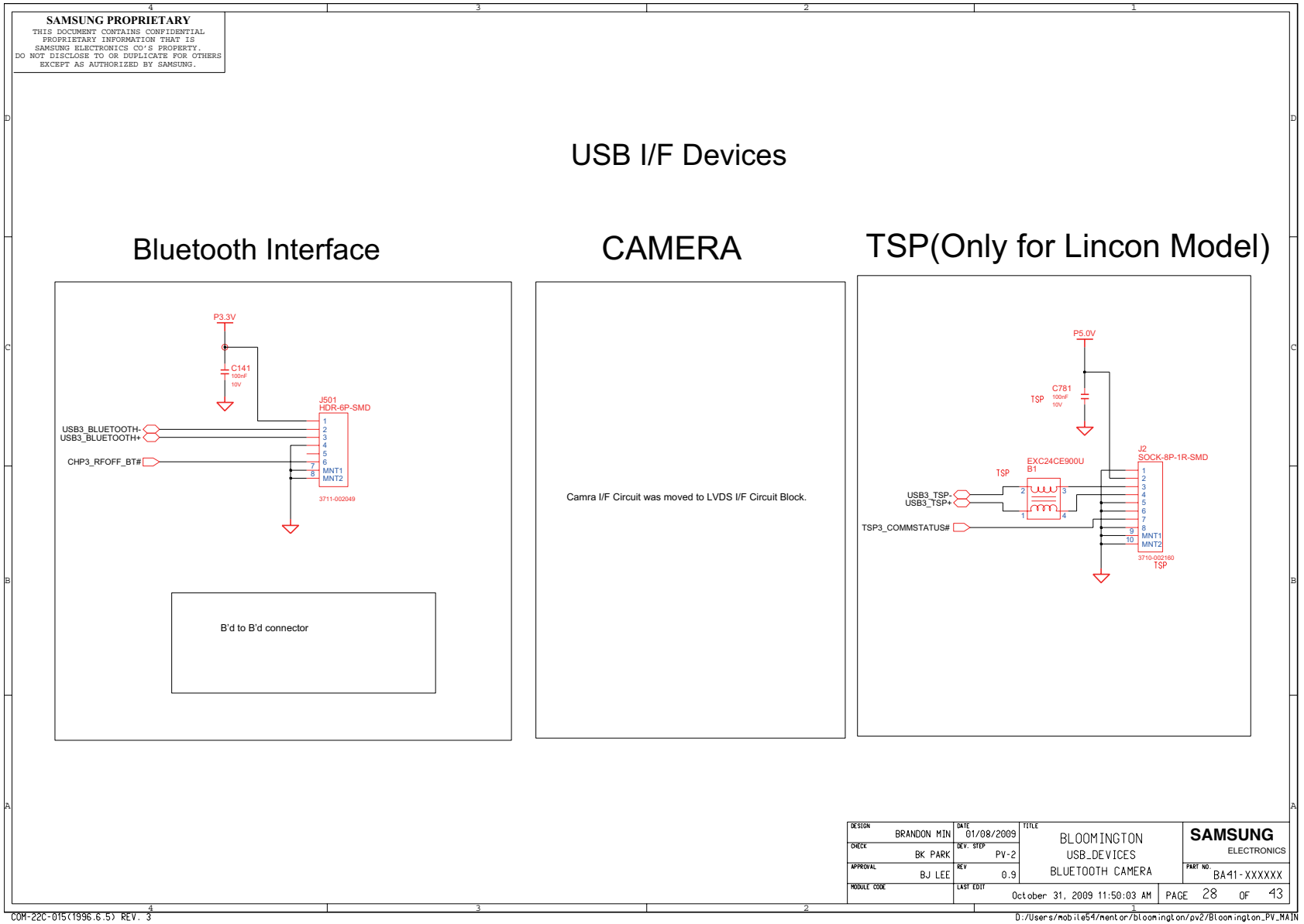


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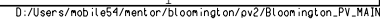




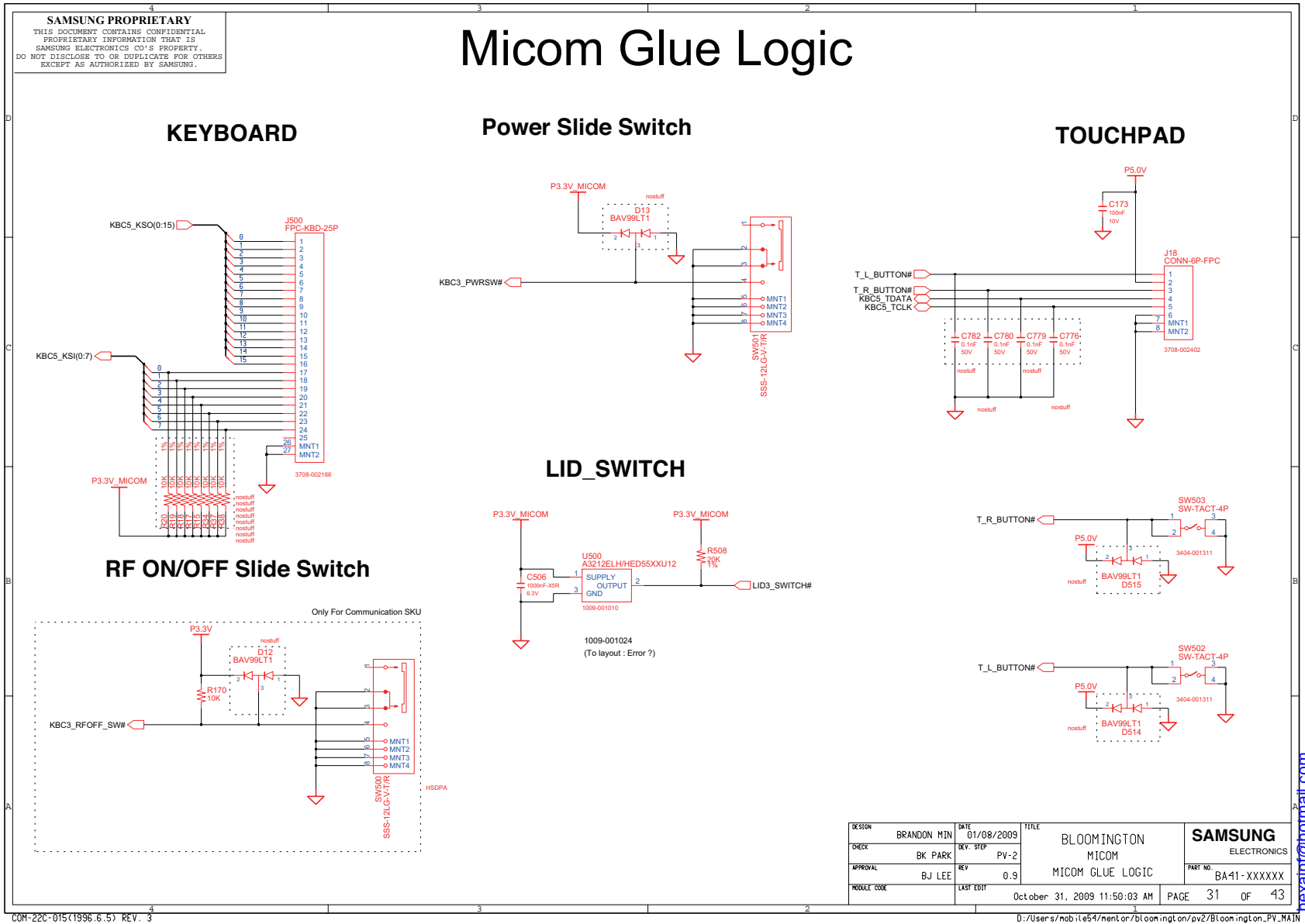
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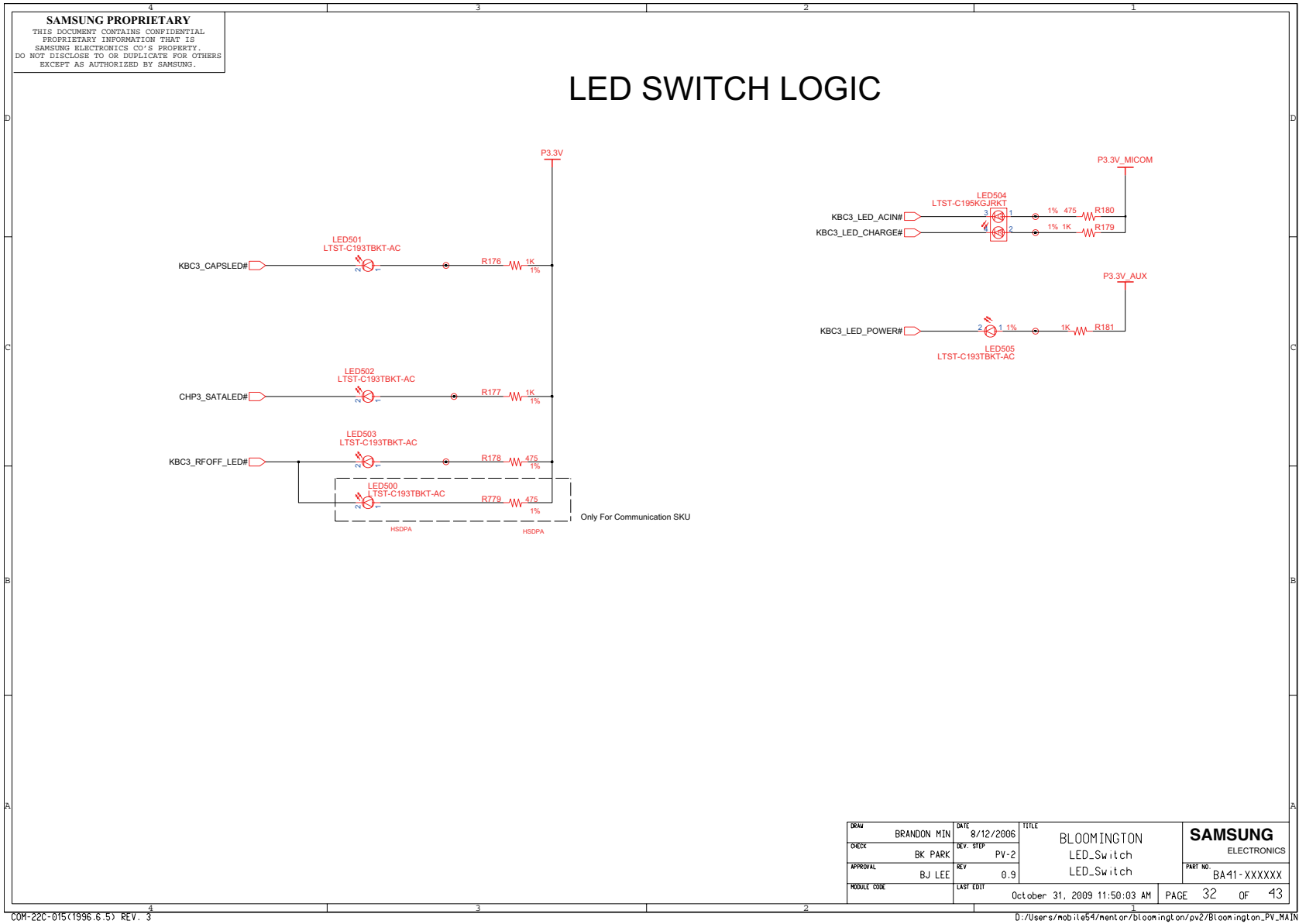




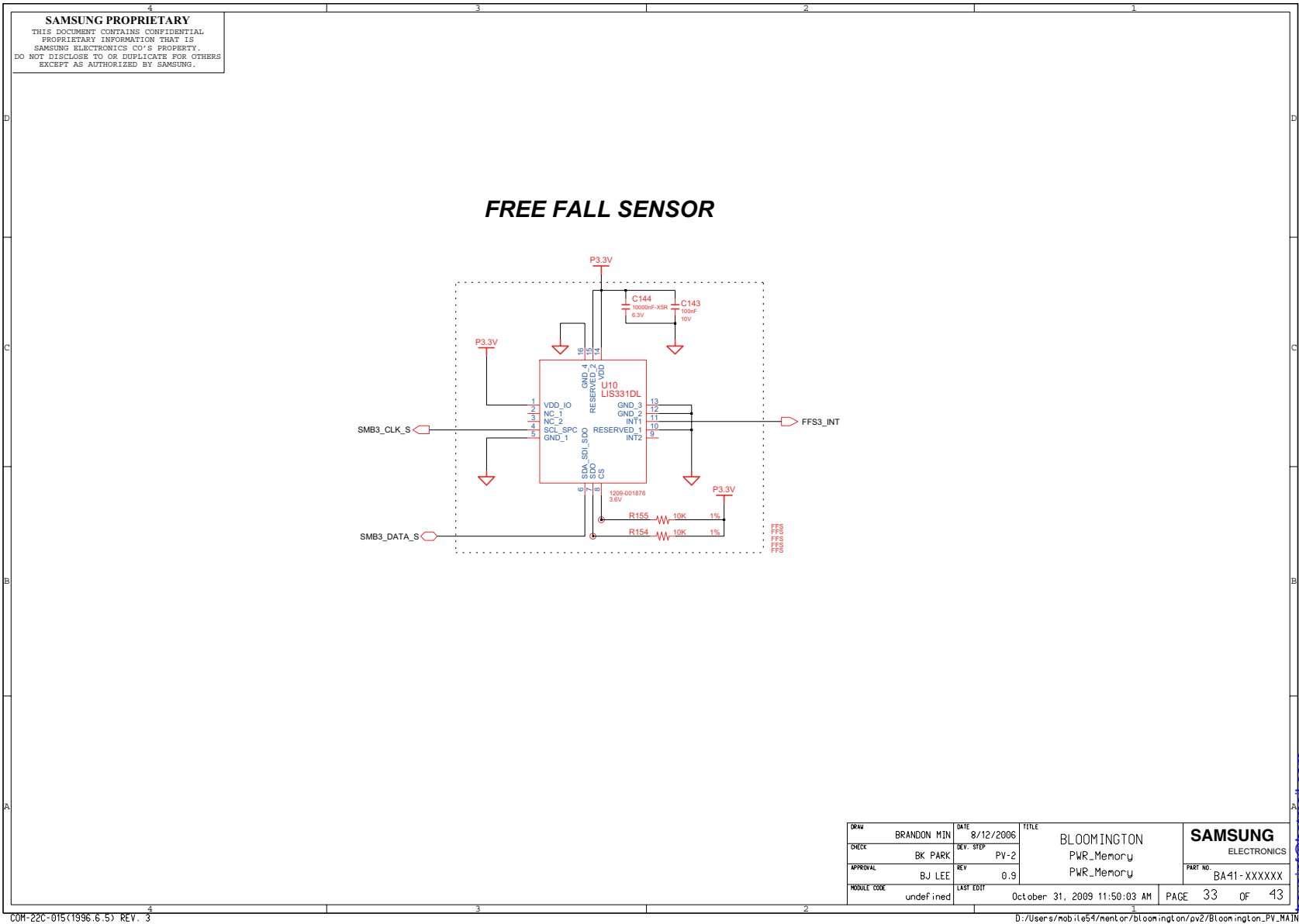
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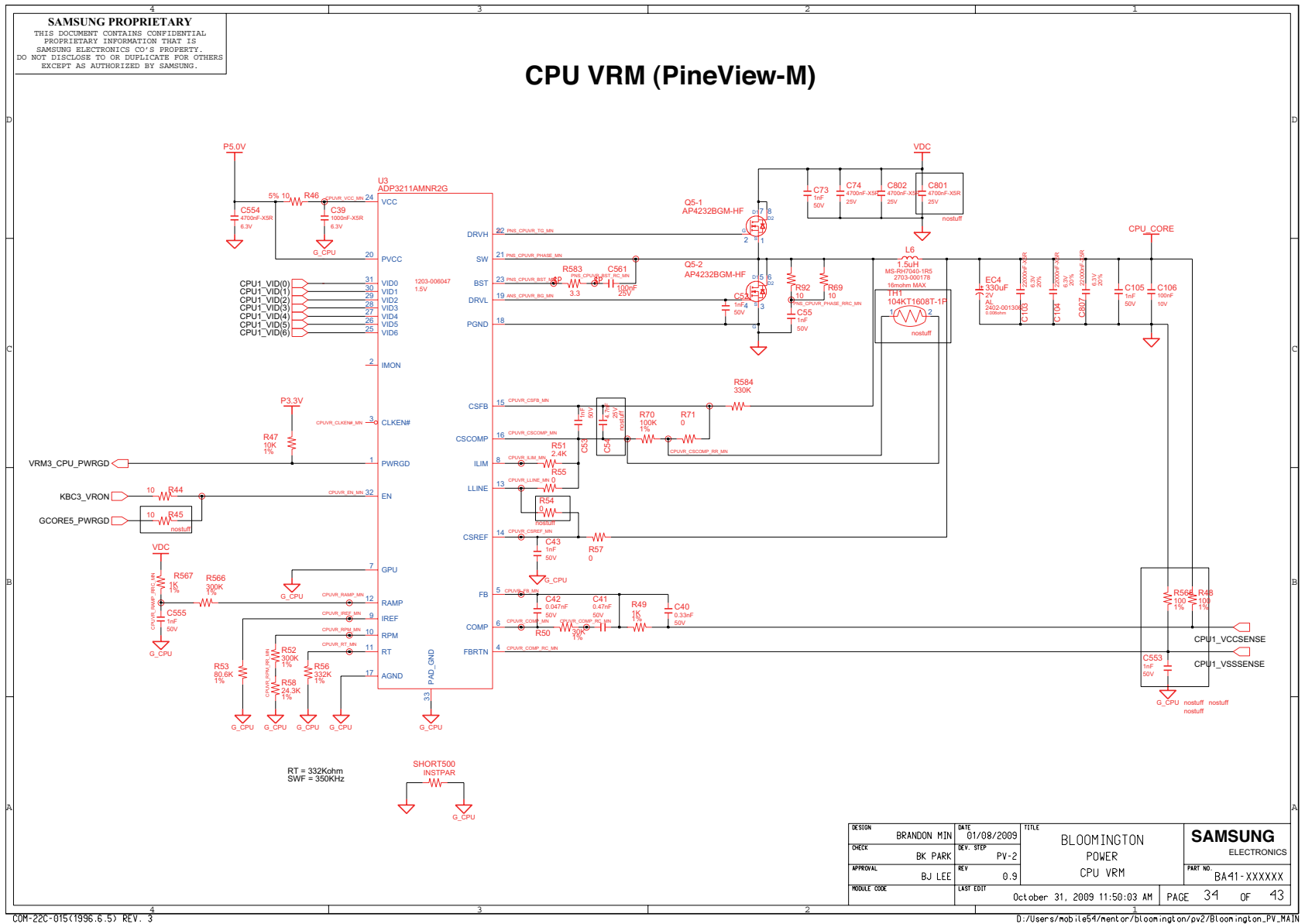
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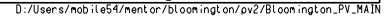
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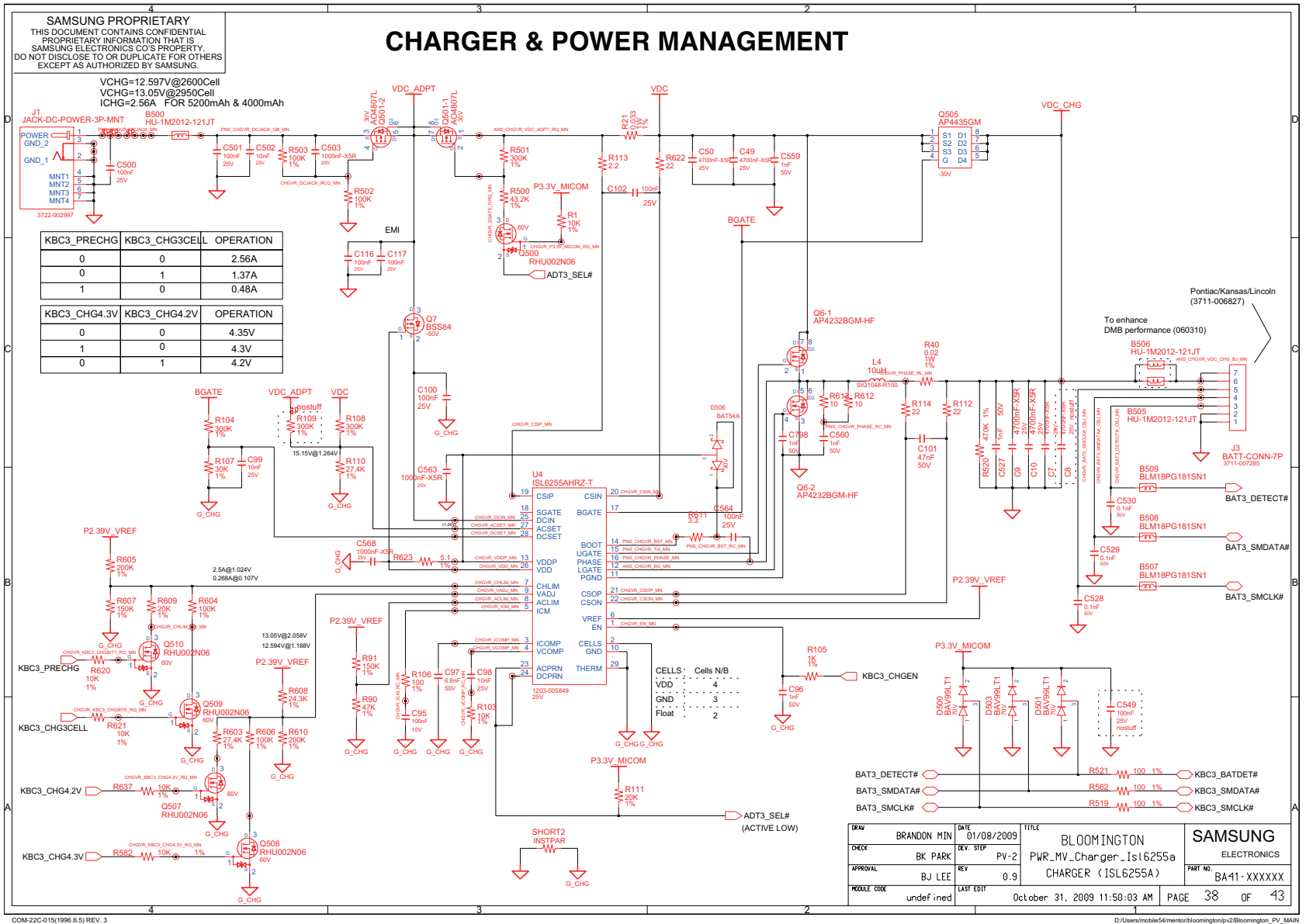




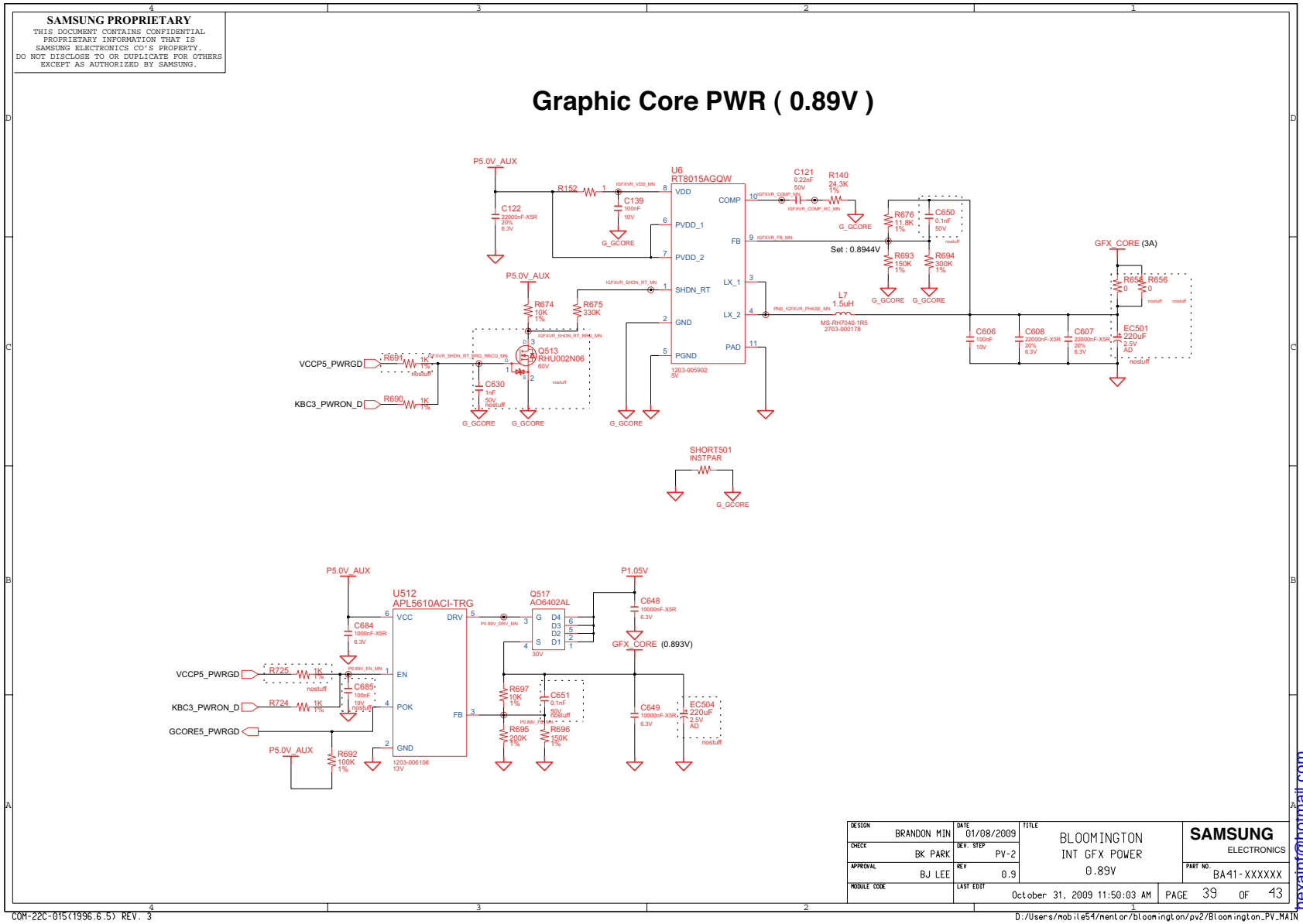




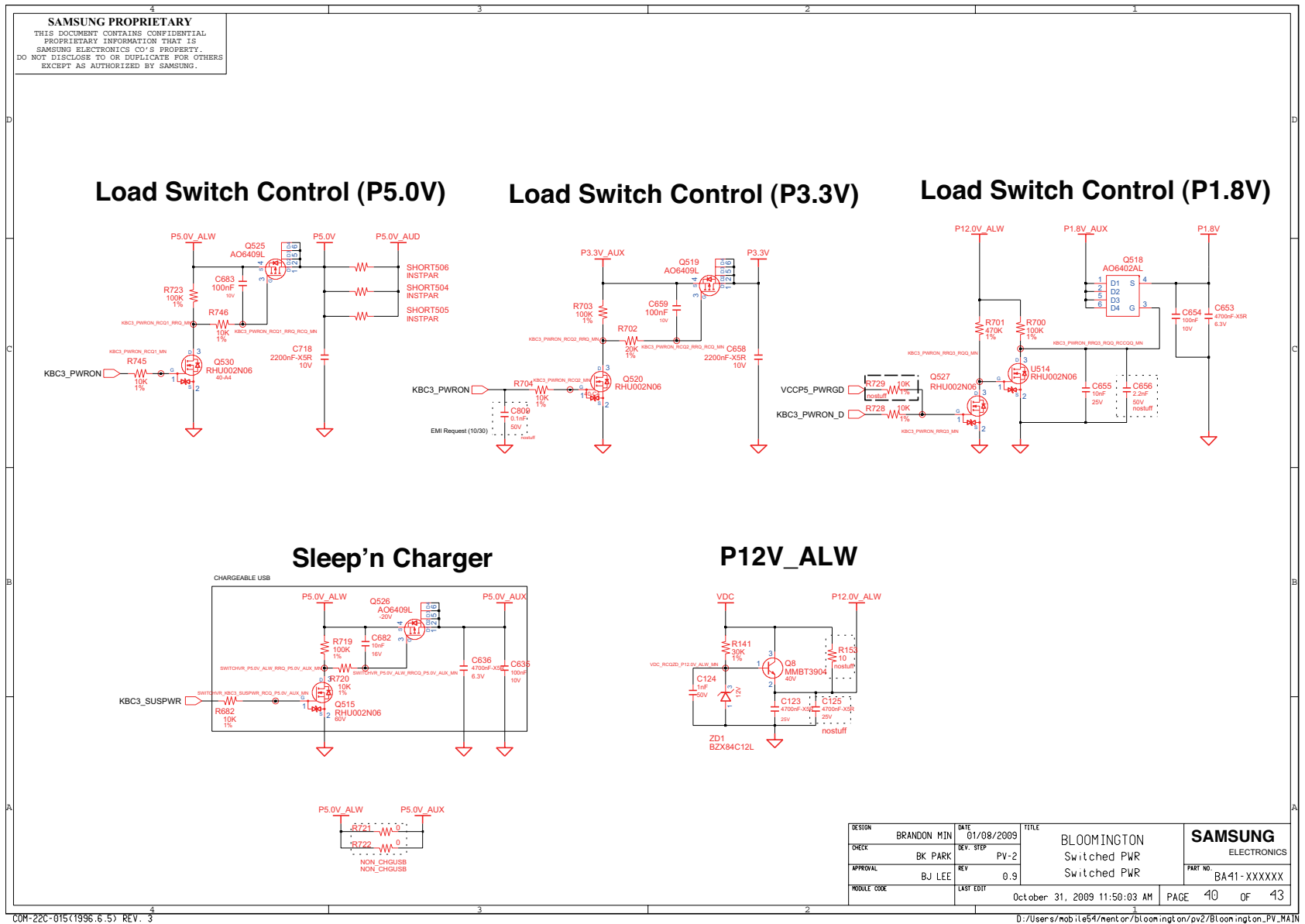
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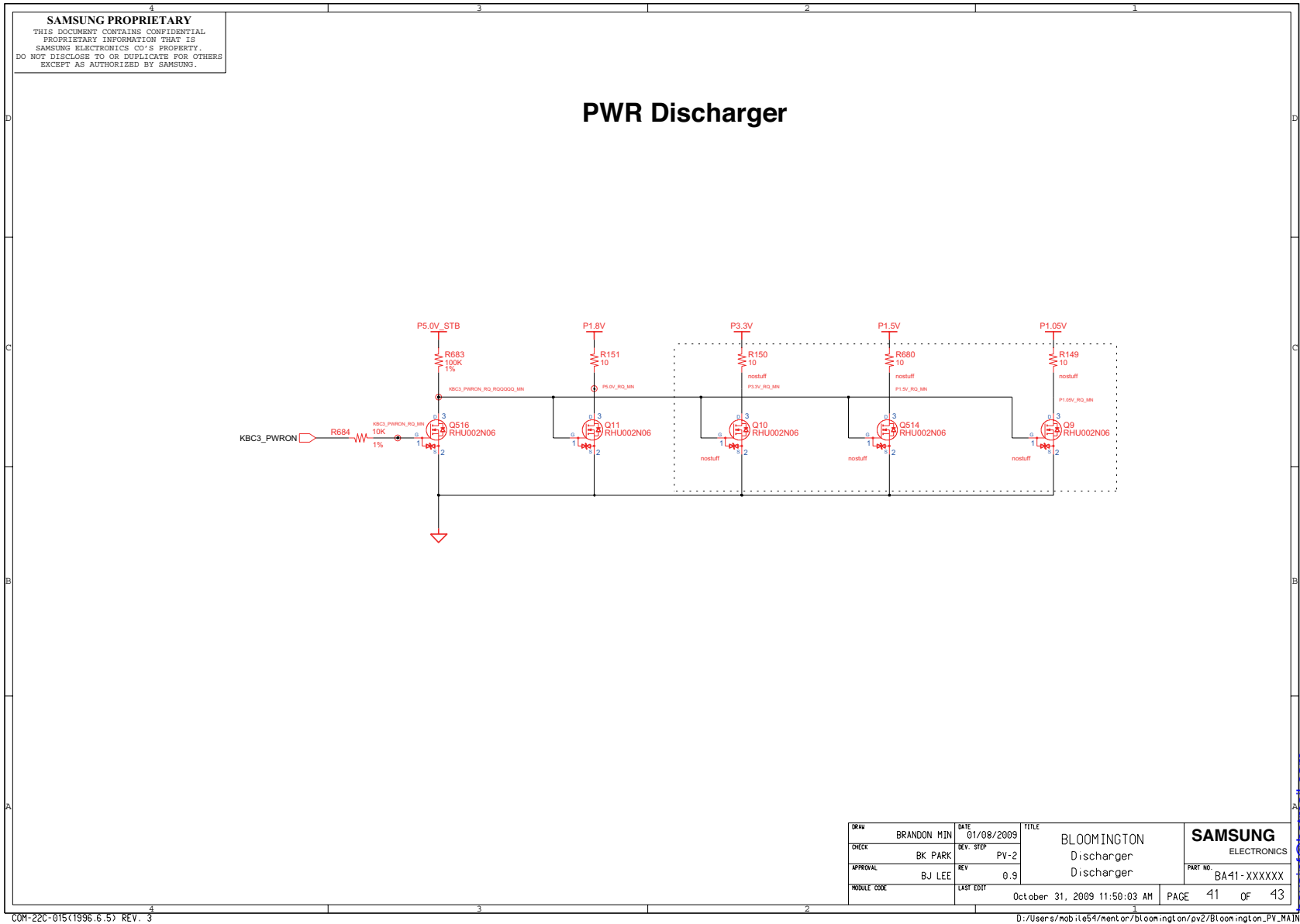
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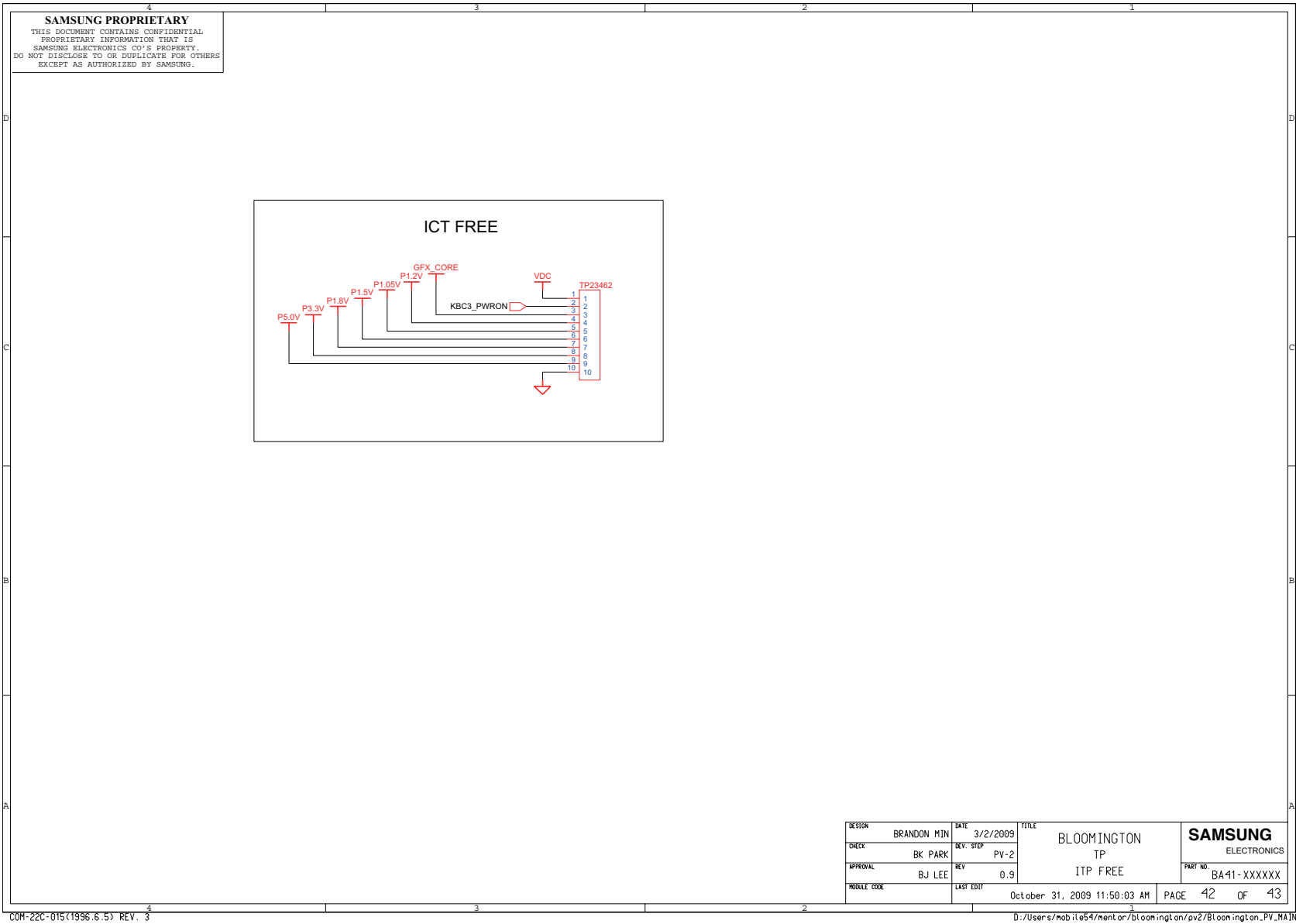
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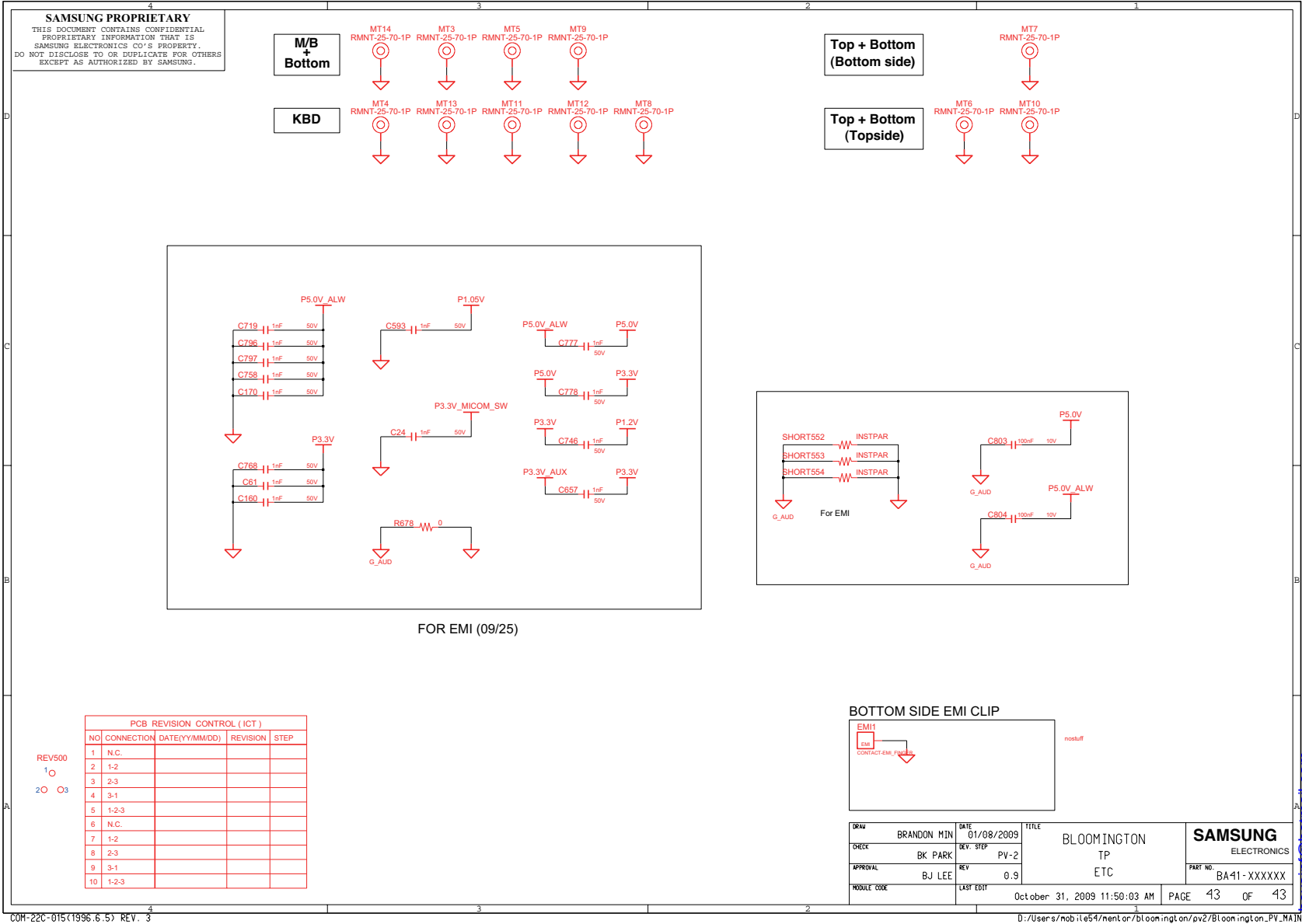
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